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(12) **United States Design Patent**  
**Horchler**

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(54) **ELECTRICAL CONNECTOR**  
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(US)

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(58) **Field of Classification Search**  
USPC ..... D13/146, 147, 149, 154, 184, 199;  
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See application file for complete search history.

(57) **CLAIM**  
The ornamental design for an electrical connector, as shown  
and described.

**DESCRIPTION**

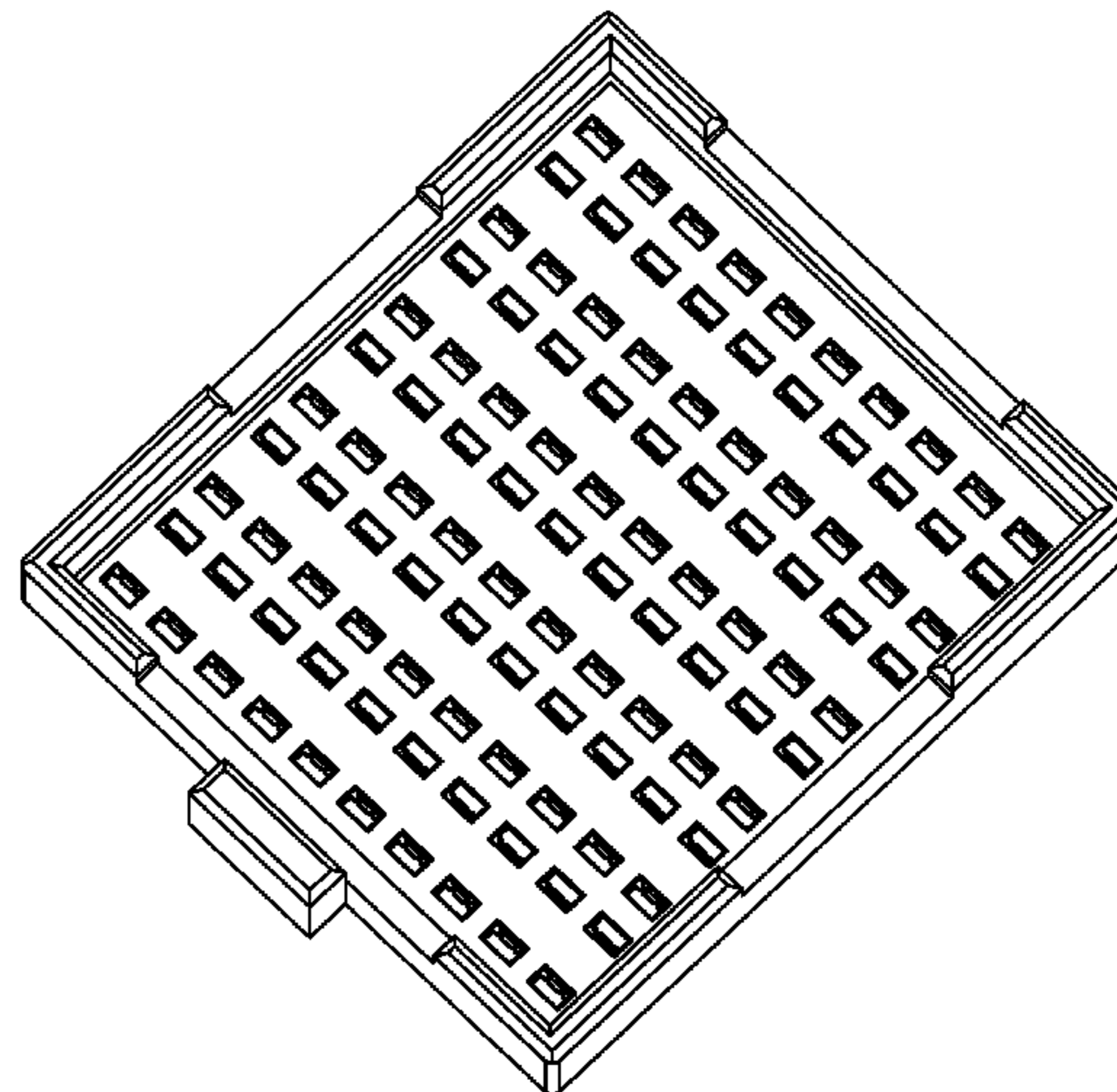
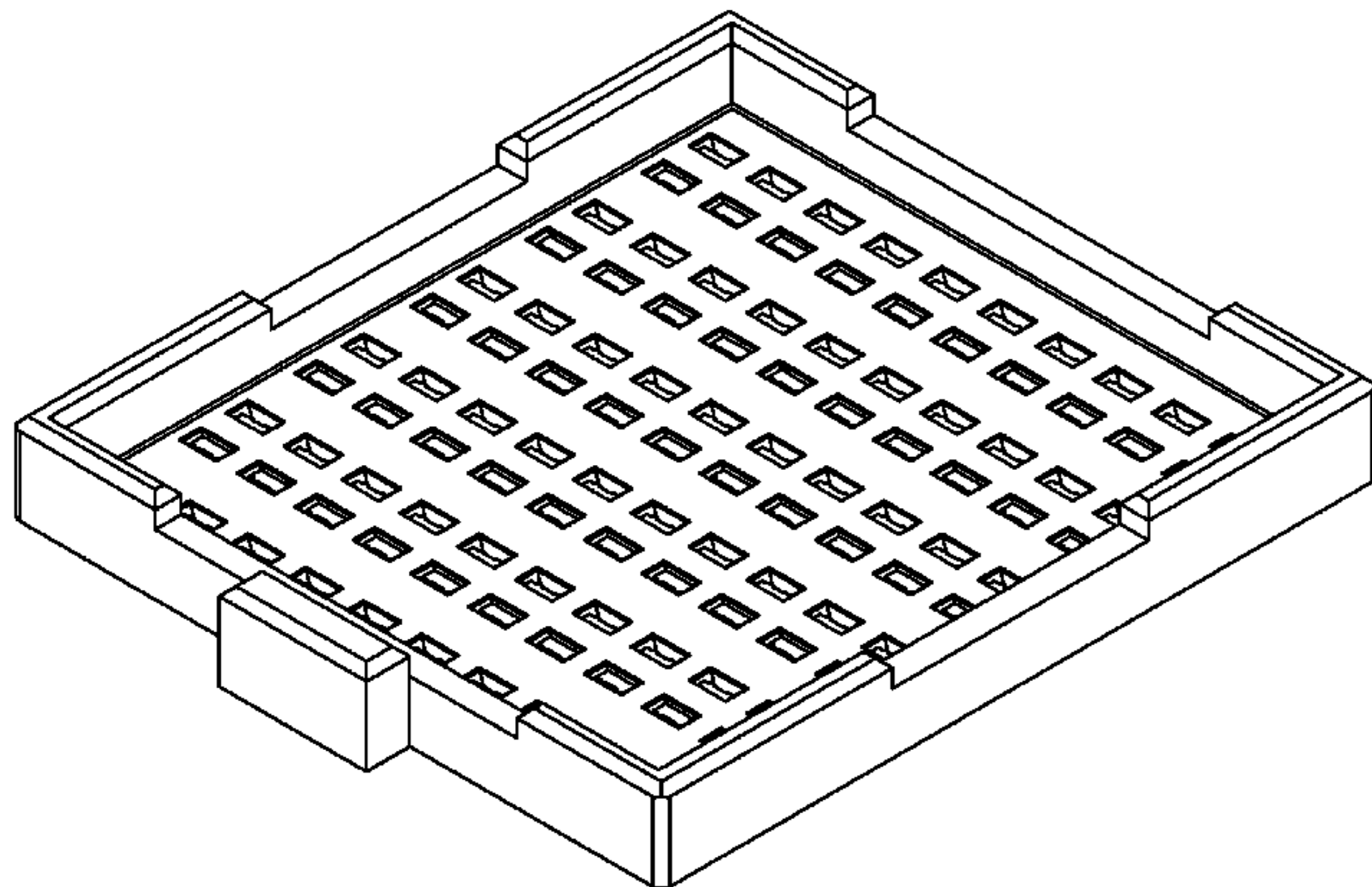
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FIG. 1 is a top, right, front perspective view of a connector housing for an electrical connector showing my new design; FIG. 2 is another top, right, front perspective view thereof; FIG. 3 is a top, left, rear perspective view thereof; FIG. 4 is a bottom, left, rear perspective view thereof; FIG. 5 is a bottom, right, front perspective view thereof; FIG. 6 is a front elevation view thereof; FIG. 7 is a rear elevation view thereof; FIG. 8 is a top plan view thereof; FIG. 9 is a bottom plan view thereof; FIG. 10 is a left side elevation view thereof; and, FIG. 11 is a right side elevation view thereof. In a preferred embodiment, the nature of this product is an electrical component that can take the form of an electrical connector, and a connector housing therefor.

**1 Claim, 7 Drawing Sheets**



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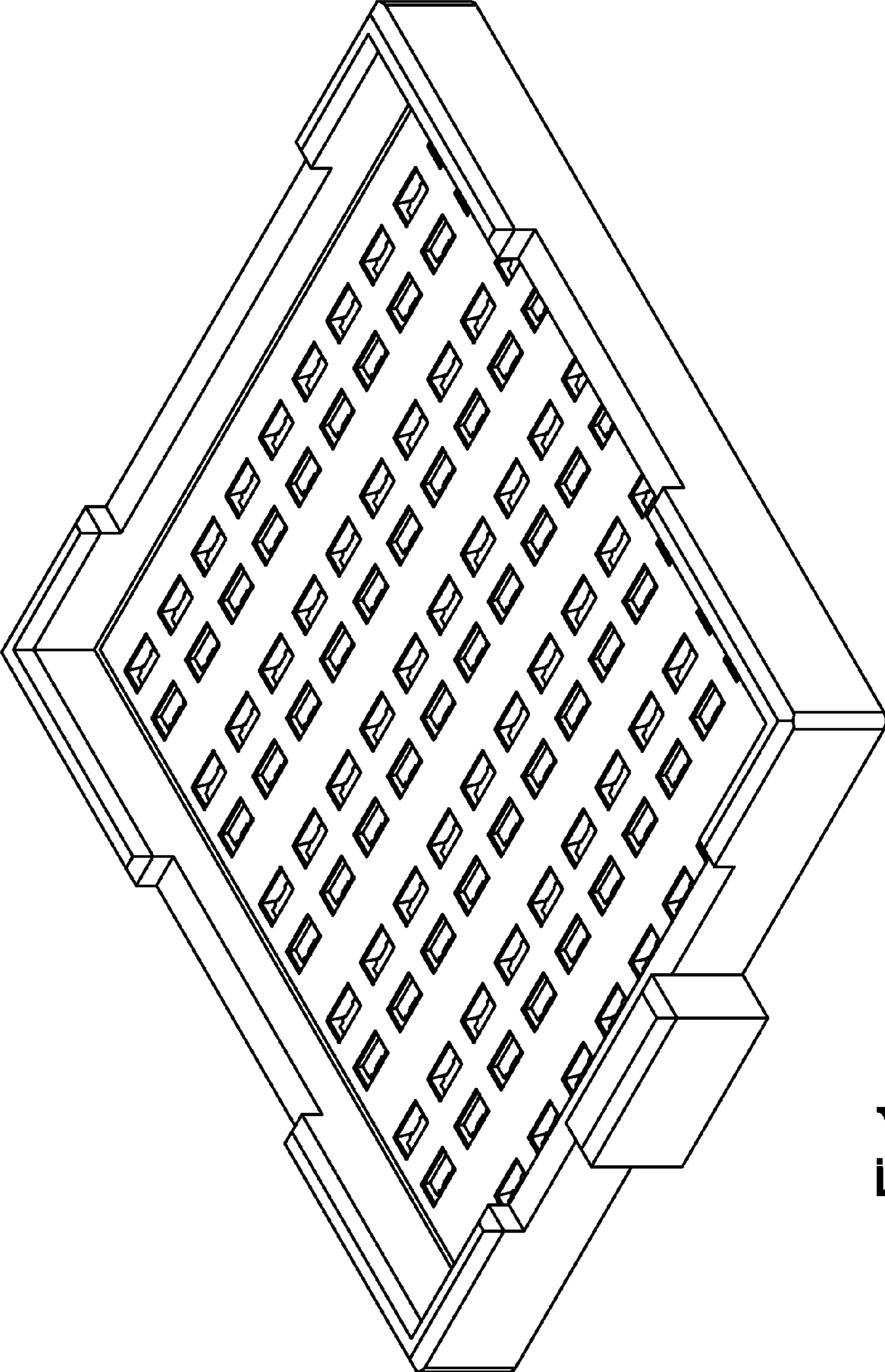


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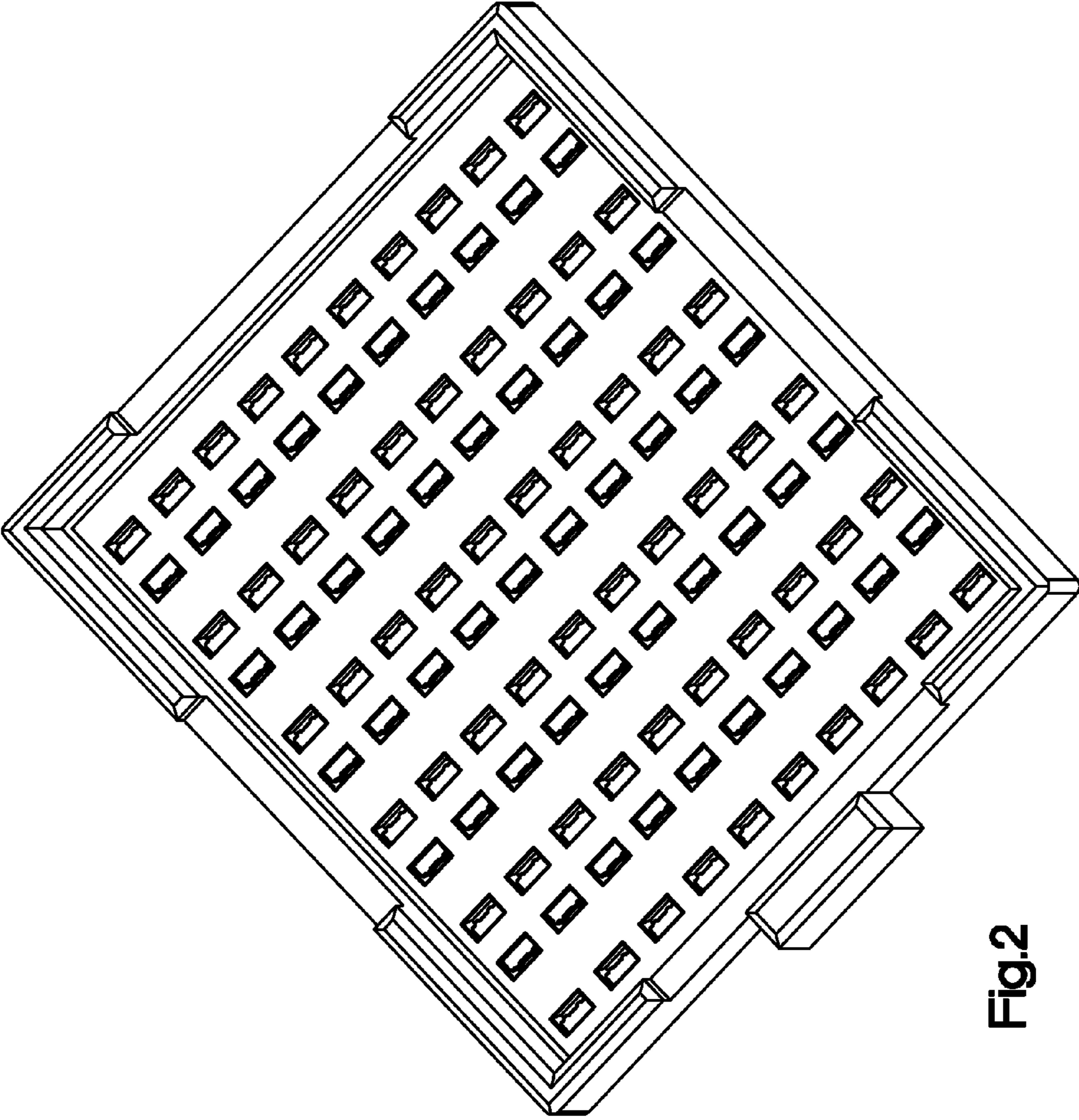


Fig.2

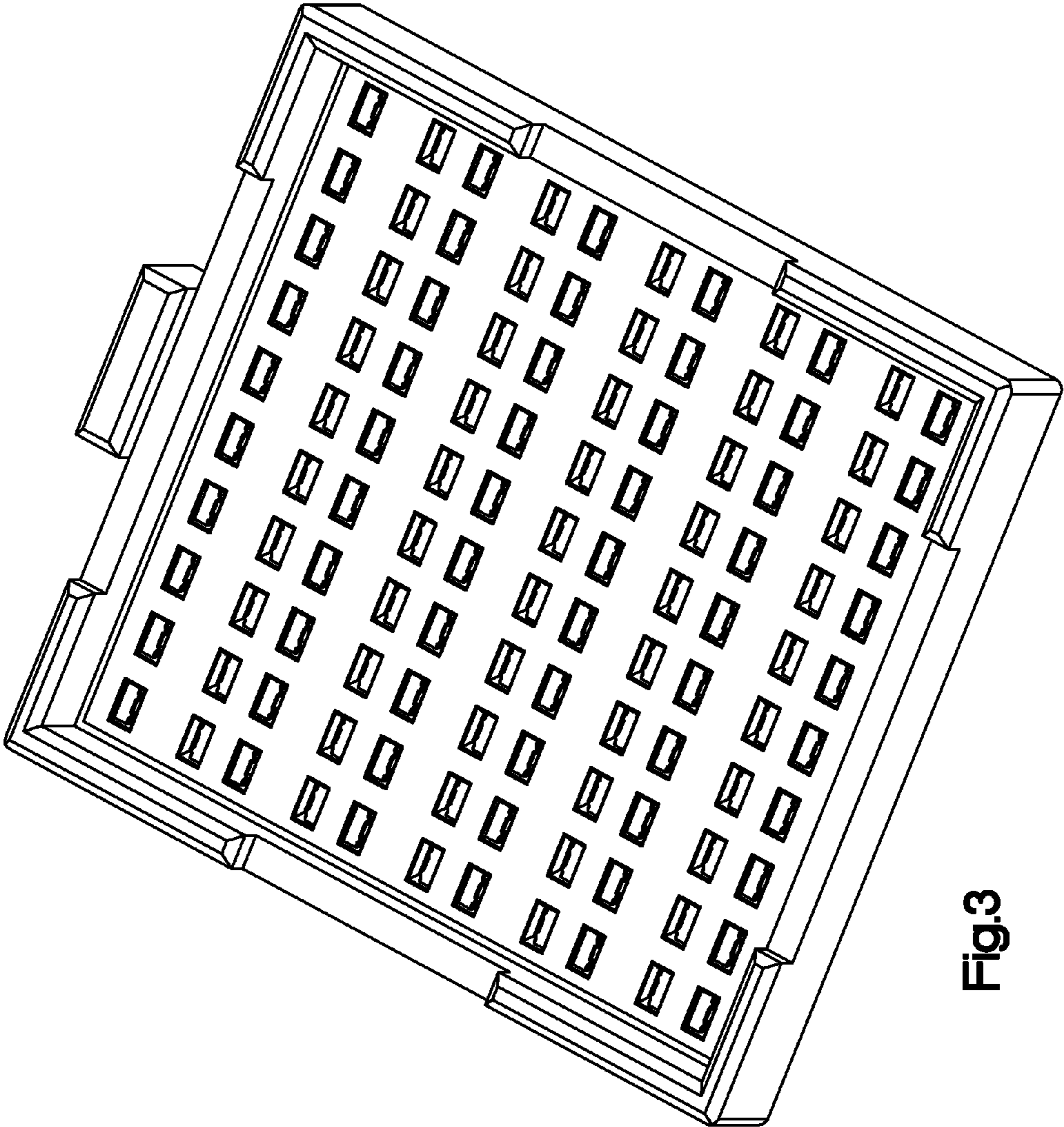


Fig.3

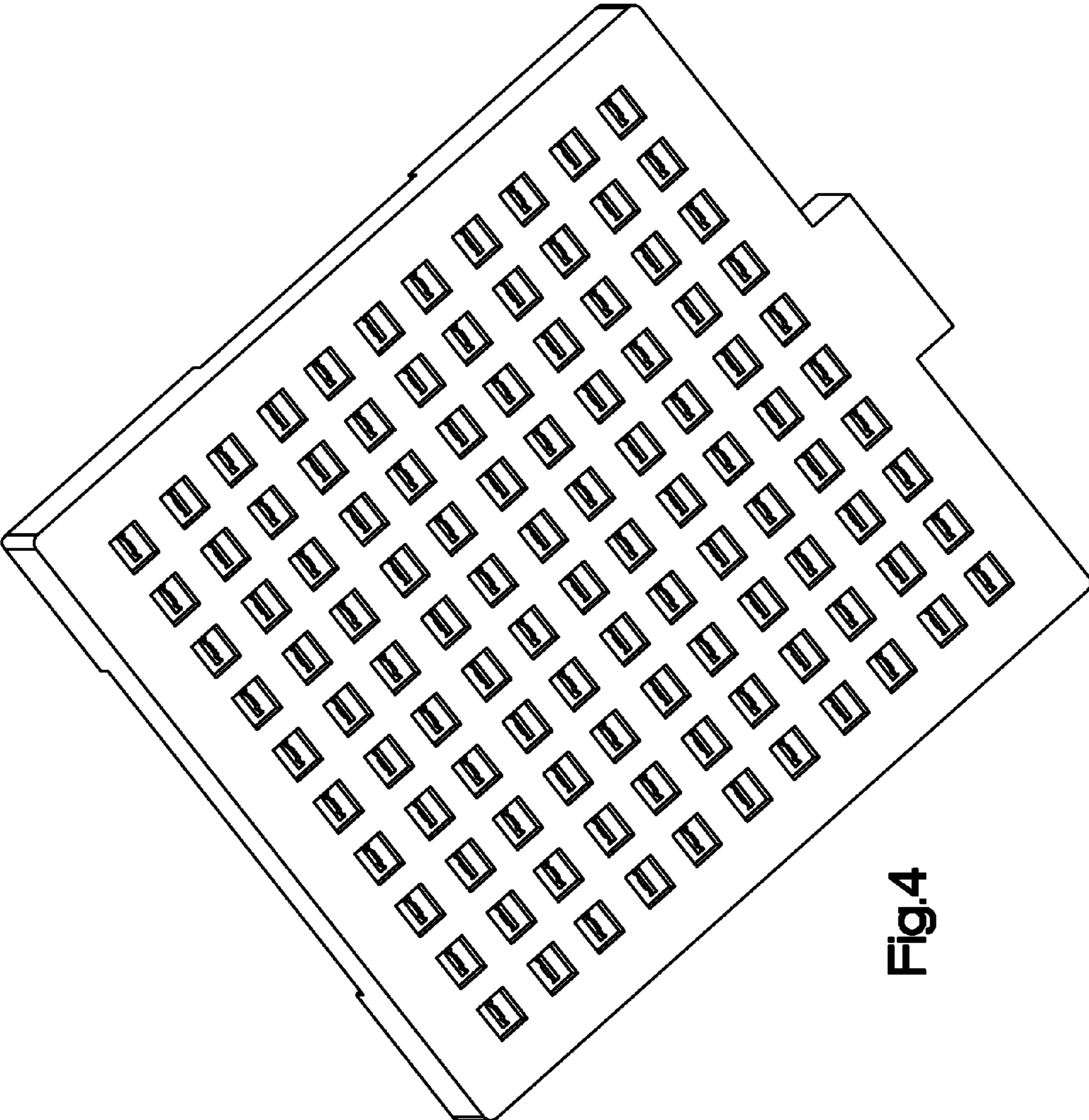


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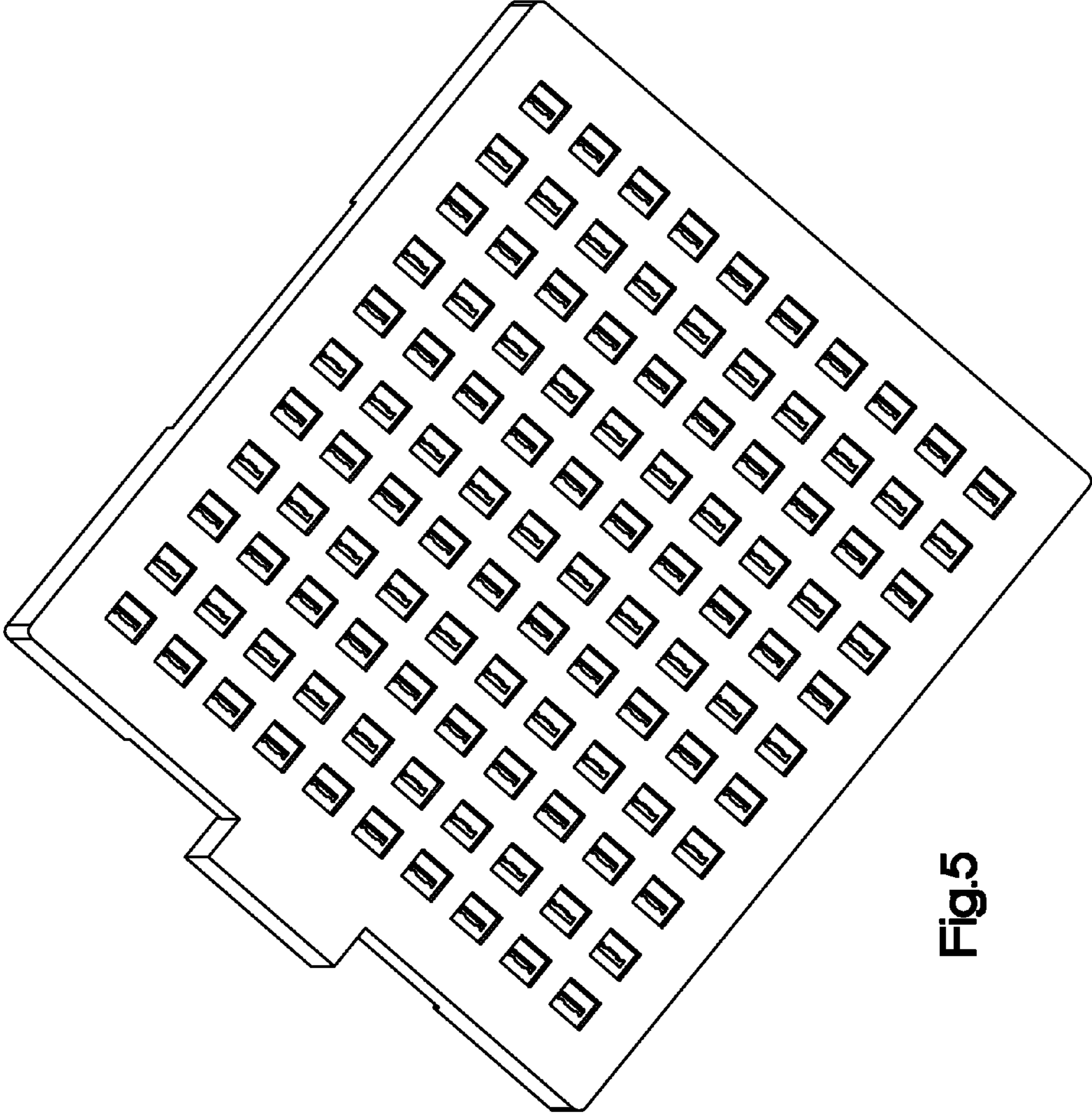


Fig.5



Fig. 6

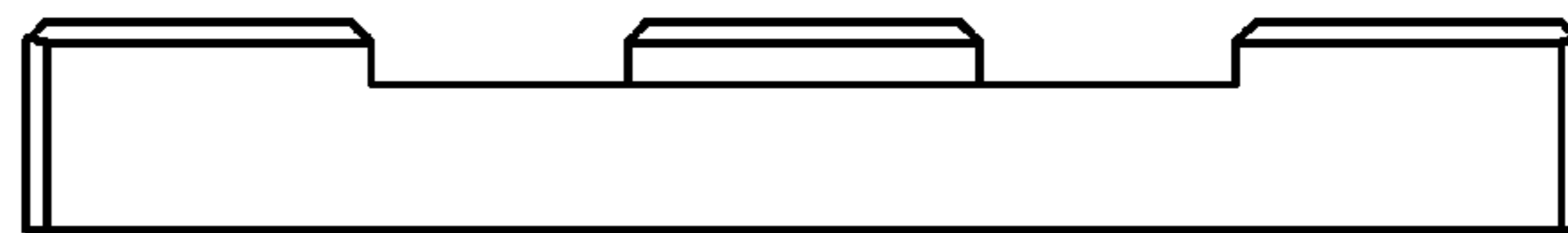


Fig. 7

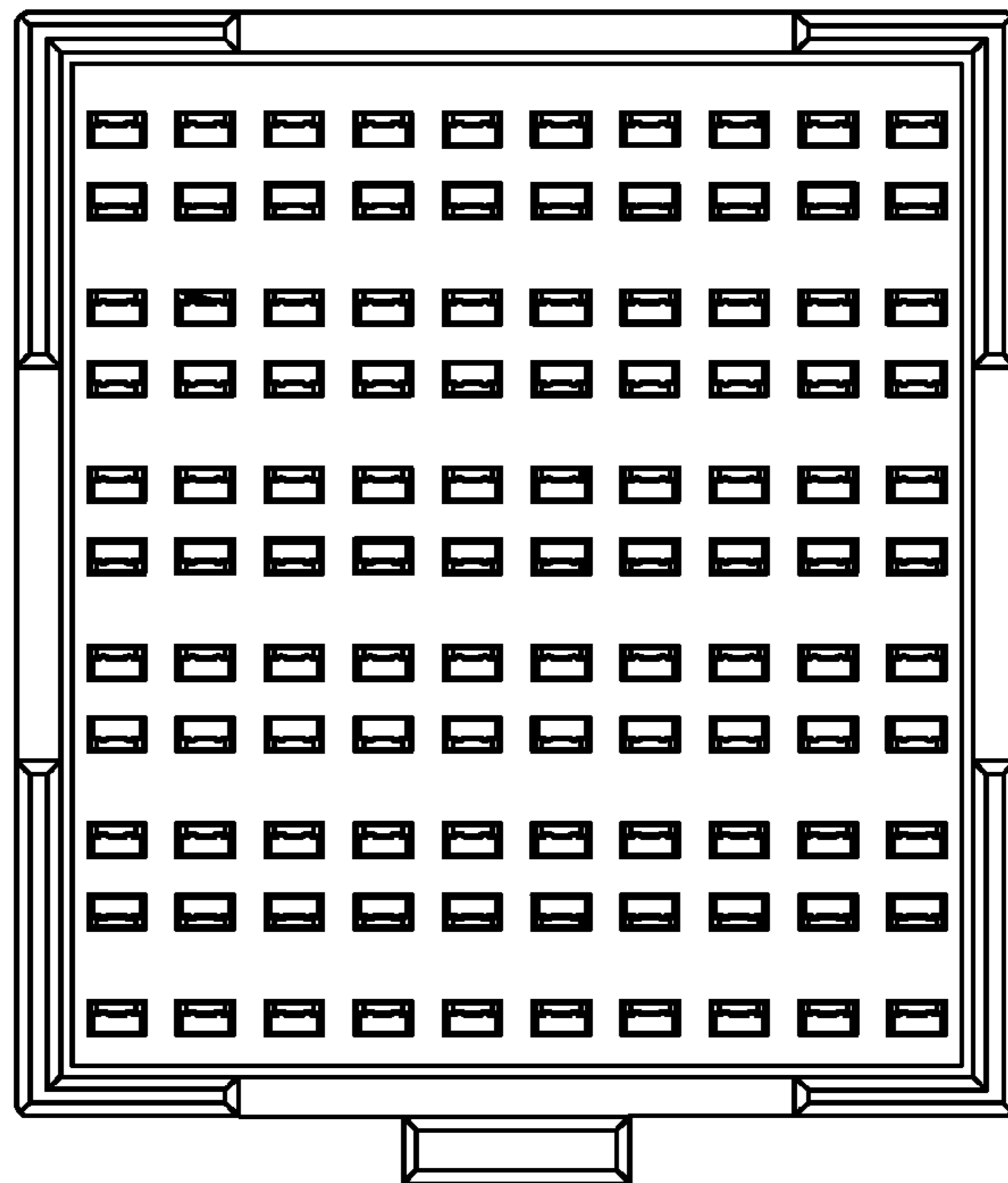


Fig. 8

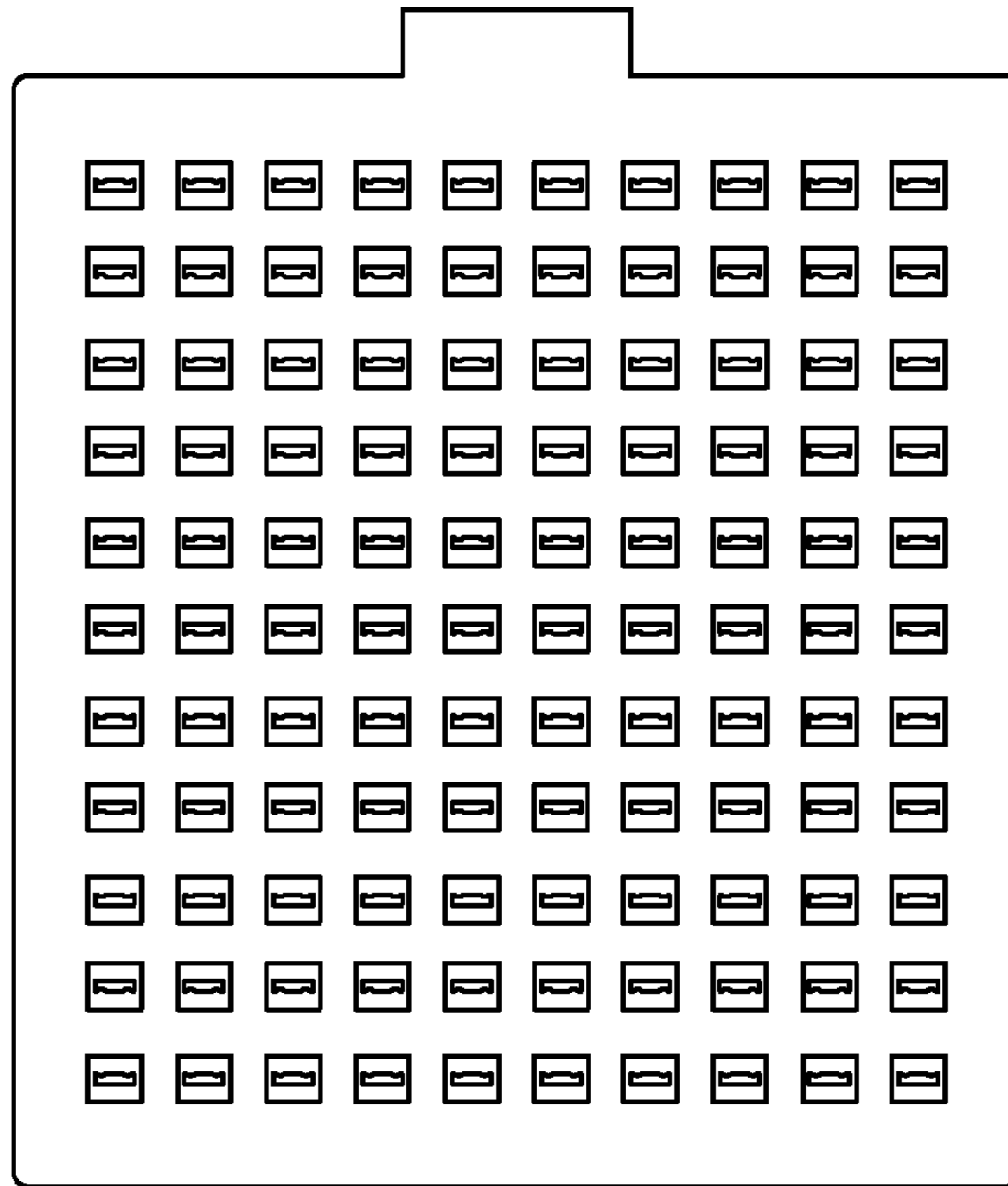


Fig.9

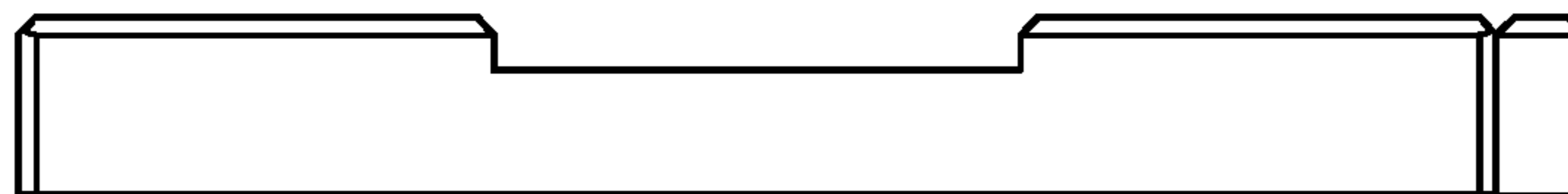


Fig.10

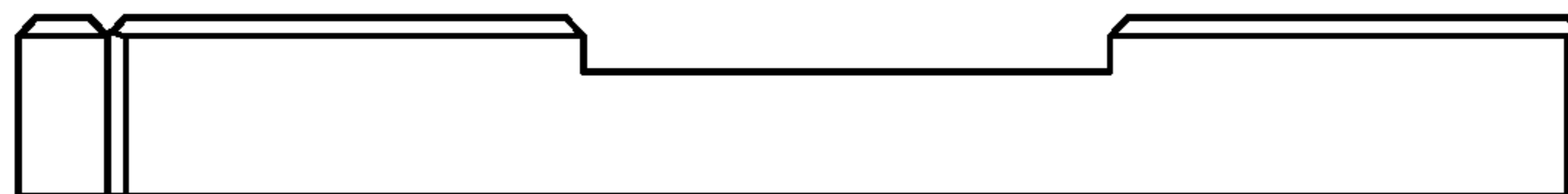


Fig.11